



**THE DATASHEET OF
DDA114EH-7**



PNP PRE-BIASED SMALL SIGNAL DUAL SURFACE MOUNT TRANSISTOR
Features

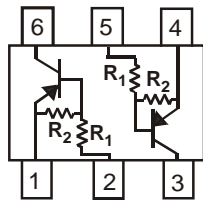
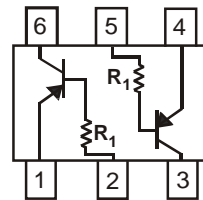
- Epitaxial Planar Die Construction
- Complementary NPN Types Available (DDC)
- Built-In Biasing Resistors
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

P/N	R1 (NOM)	R2 (NOM)
DDA124EH	22kΩ	22kΩ
DDA144EH	47kΩ	47kΩ
DDA143EH	4.7kΩ	4.7kΩ
DDA114YH	10kΩ	47kΩ
DDA123JH	2.2kΩ	47kΩ
DDA114EH	10kΩ	10kΩ
DDA143TH	4.7kΩ	—
DDA114TH	10kΩ	—

Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Terminal Connections: See Diagram
- Weight: 0.005 grams (Approximate)

SCHEMATIC DIAGRAM, TOP VIEW


 R₁, R₂ Device Schematic

 R₁ Only Device Schematic

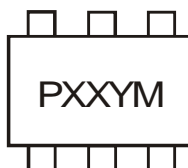
Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DDA124EH-7	AEC-Q101	P17	7	8	3,000
DDA144EH-7	AEC-Q101	P20	7	8	3,000
DDA143EH-7	AEC-Q101	P08	7	8	3,000
DDA114YH-7	AEC-Q101	P14	7	8	3,000
DDA123JH-7	AEC-Q101	P06	7	8	3,000
DDA114EH-7	AEC-Q101	P13	7	8	3,000
DDA143TH-7	AEC-Q101	P07	7	8	3,000
DDA114TH-7	AEC-Q101	P12	7	8	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

SOT563



PXX = Product Type Marking Code
 YM = Date Code Marking
 Y = Year ex: C = 2015
 M = Month ex: 9 = September

Date Code Key

Year	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024
Code	C	D	E	F	G	H	I	J	K	L

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	V _{CC}	-50	V
Input Voltage	V _{IN}	+10 to -40 +10 to -40 +10 to -30 +6 to -40 +5 to -12 +10 to -40 +5V Max +5V Max	V
Output Current	I _O	-30 -30 -100 -70 -100 -50 -100 -100	mA
Output Current	I _C (Max)	-100	mA
Power Dissipation	P _D	150	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	R _{θJA}	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Note: 5. Mounted on FR4 Board with recommended pad layout at <http://www.diodes.com/package-outlines.html>.

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

Characteristic (DDA143TH & DDA114TH only)	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-50	—	—	V	I _C = -50μA
Collector-Emitter Breakdown Voltage	BV _{CEO}	-50	—	—	V	I _C = -1mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-5	—	—	V	I _E = -50μA
Collector Cut-Off Current	I _{CBO}	—	—	-0.5	μA	V _{CB} = -50V
Emitter Cut-Off Current	I _{EBO}	—	—	-0.5	μA	V _{EB} = -4V
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	—	—	-0.3	V	I _C /I _B = -2.5mA / -0.25mA DDA143TH I _C /I _B = -1mA / -0.1mA DDA114TH
DC Current Transfer Ratio	h _{FE}	100	250	600	—	I _C = -1mA, V _{CE} = -5V
Gain-Bandwidth Product*	f _T	—	250	—	MHz	V _{CE} = -10V, I _E = 5mA, f = 100MHz

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Input Voltage	V _{L(OFF)}	-0.5	-1.1	—	V	V _{CC} = -5V, I _O = -100μA
		-0.5	-1.1	—		
-0.5		-1.1	—			
-0.3		—	—			
-0.5		—	—			
-0.5		-1.1	—			
Input Voltage	V _{L(ON)}	—	-1.9	-3.0	V	V _O = -0.3V, I _O = -5mA V _O = -0.3V, I _O = -2mA V _O = -0.3V, I _O = -20mA V _O = -0.3V, I _O = -1mA V _O = -0.3V, I _O = -5mA V _O = -0.3V, I _O = -10mA
		—	-1.9	-3.0		
		—	-1.9	-3.0		
		—	—	-1.4		
		—	—	-1.1		
		—	-1.9	-3.0		
Output Voltage	V _{O(ON)}	—	-0.1	-0.3	V	I _O /I _L = -10mA / -0.5mA I _O /I _L = -10mA / -0.5mA I _O /I _L = -10mA / -0.5mA I _O /I _L = -5mA / -0.25mA I _O /I _L = -5mA / -0.25mA I _O /I _L = -10mA / -0.5mA
		—	-0.1	-0.3		
		—	-0.1	-0.3		
		—	—	—		
		—	—	—		
		—	—	—		
Input Current	I _L	—	—	-0.36	mA	V _I = -5V
		—	—	-0.18		
		—	—	-1.8		
		—	—	-0.88		
		—	—	-3.6		
		—	—	-0.88		
Output Current	I _{O(OFF)}	—	—	-0.5	μA	V _{CC} = -50V, V _I = -0V
DC Current Gain	G _L	56	—	—	—	V _O = -5V, I _O = -5mA V _O = -5V, I _O = -5mA V _O = -5V, I _O = -10mA V _O = -5V, I _O = -10mA V _O = -5V, I _O = -10mA V _O = -5V, I _O = -5mA
		68	—	—		
		20	—	—		
		68	—	—		
		80	—	—		
		30	—	—		
Gain-Bandwidth Product*	f _T	—	250	—	MHz	V _{CE} = -10V, I _E = -5mA, f = 100MHz

* Transistor - For Reference Only

Typical Curves - DDA143EH

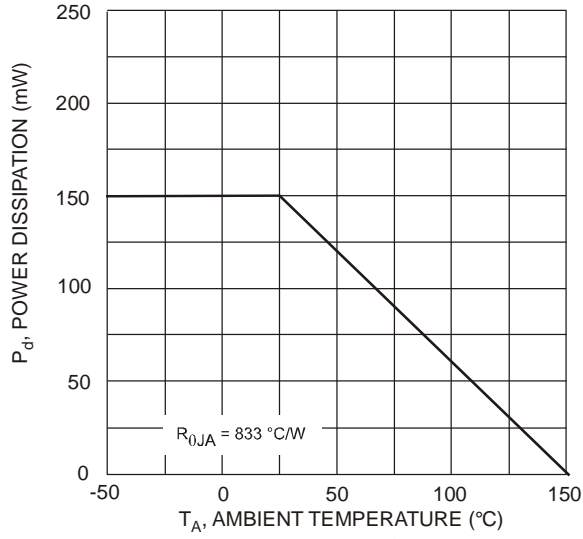


Fig. 1 Derating Curve

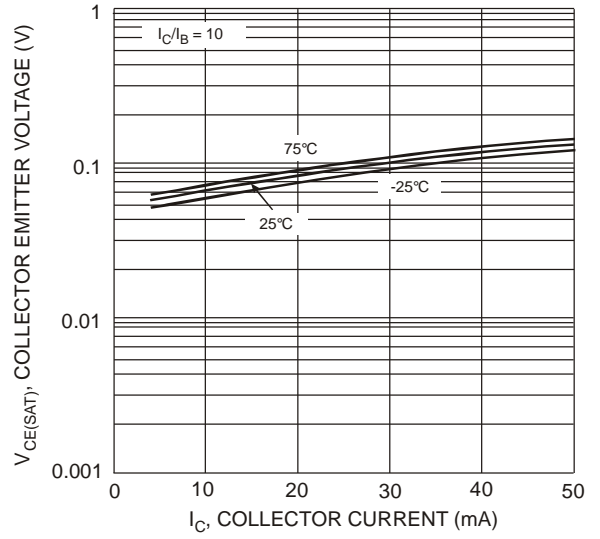


Fig. 2 V_{CE(SAT)} vs. I_C

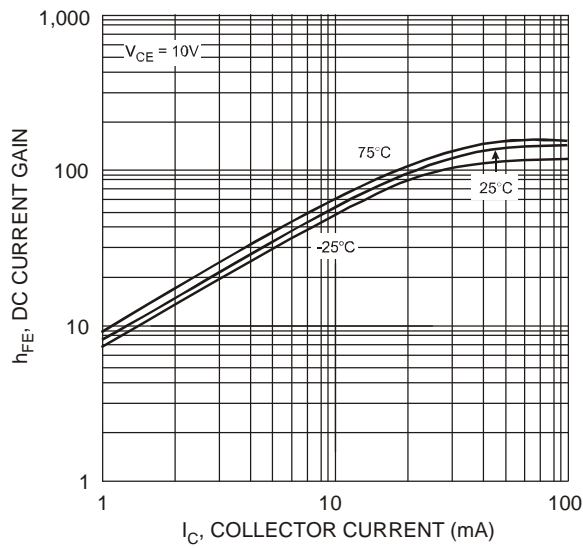


Fig. 3 DC Current Gain

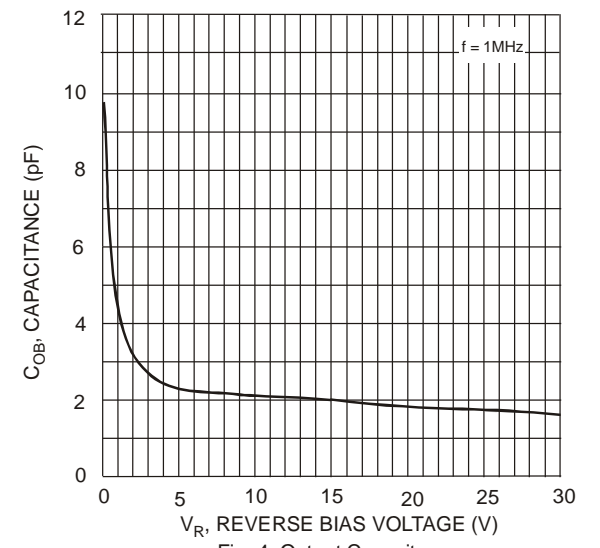


Fig. 4 Output Capacitance

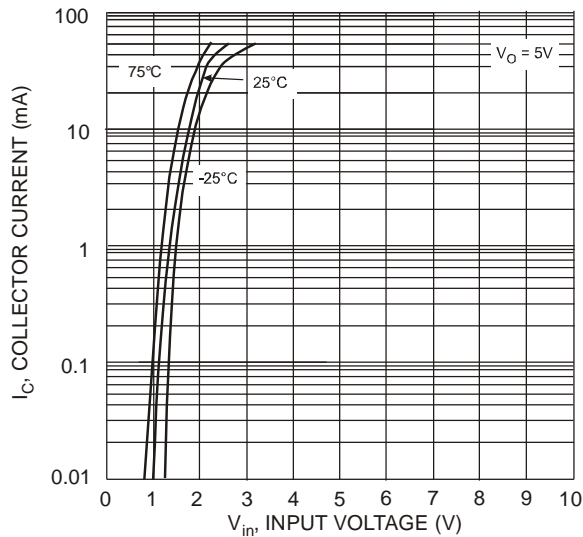


Fig. 5 Collector Current vs. Input Voltage

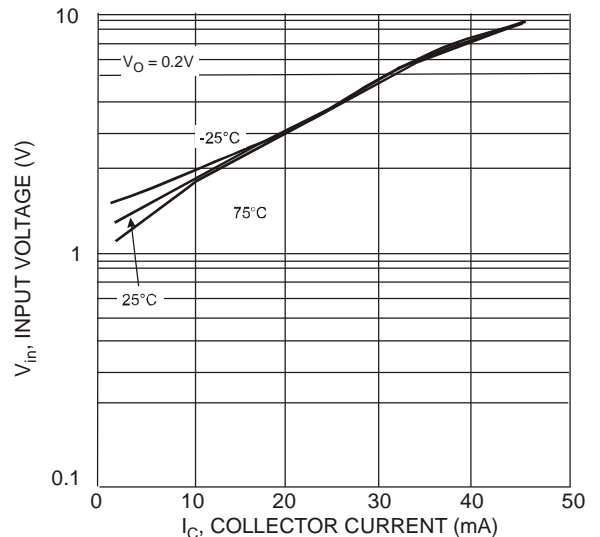
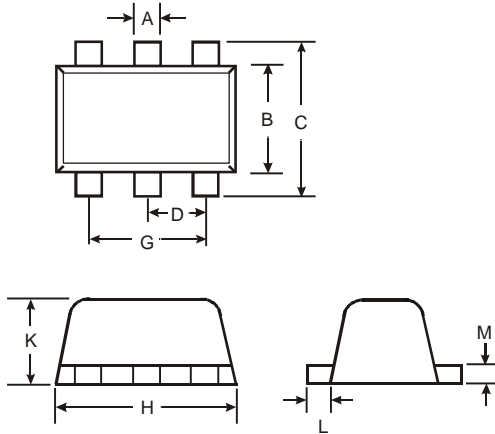


Fig. 6 Input Voltage vs. Collector Current

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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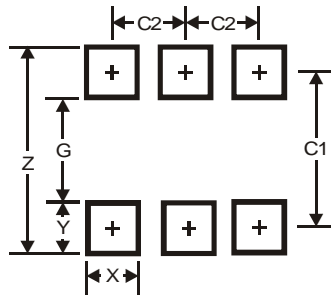


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Dim	Min	Max	Typ
A	0.15	0.30	0.20
B	1.10	1.25	1.20
C	1.55	1.70	1.60
D	-	-	0.50
G	0.90	1.10	1.00
H	1.50	1.70	1.60
K	0.55	0.60	0.60
L	0.10	0.30	0.20
M	0.10	0.18	0.11
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563



Dimensions	Value (in mm)
Z	2.2
G	1.2
X	0.375
Y	0.5
C1	1.7
C2	0.5

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